



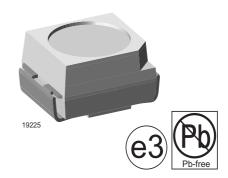
High Intensity SMD LED

Description

These new devices have been designed to meet the increasing demand for surface mounting technology. This device is used for outdoor or for low power applications.

The package of the TLMD310. is the PLCC-2 (equivalent to a size B tantalum capacitor).

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.



Features

- SMD LEDs with exceptional brightness
- · Luminous intensity categorized
- · Compatible with automatic placement equipment
- · EIA and ICE standard package
- Compatible with infrared, vapor phase and wave solder processes according to CECC
- · Available in 8 mm tape
- Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packaging unit $I_{Vmax}/I_{Vmin} \le 2.0$, optional ≤ 1.6
- · Lead-free device

Applications

Automotive:

Backlighting in dashboards and switches

Telecommunication:

Indicator and backlighting in telephone and fax
Indicator and backlight for audio and video equipment
Indicator and backlight for battery driven equipment
Small indicator for outdoor applications
Indicator and backlight in office equipment
Flat backlight for LCDs, switches and symbols
General use

Parts Table

Part	Color, Luminous Intensity	Angle of Half Intensity (±φ)	Technology
TLMD3100	Red, I _v > 20 mcd (typ.)	60 °	GaAIAs on GaAs
TLMD3101	Red, I _V = (16 to 50) mcd	60 °	GaAlAs on GaAs
TLMD3105	Red, I _V = (10 to 32) mcd	60 °	GaAlAs on GaAs

Absolute Maximum Ratings

 $T_{amb} = 25 \, ^{\circ}\text{C}$, unless otherwise specified **TLMD310**.

Parameter	Test condition	Symbol	Value	Unit
Reverse voltage		V_{R}	6	V
DC Forward current		I _F	30	mA
Surge forward current	t _p ≤ 10 μs	I _{FSM}	0.5	A
Power dissipation	T _{amb} ≤ 60 °C	P_V	100	mW

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Parameter	Test condition	Symbol	Value	Unit
Junction temperature		T _j	100	°C
Operating temperature range		T _{amb}	- 40 to + 100	°C
Storage temperature range		T _{stg}	- 55 to + 100	°C
Soldering temperature	t ≤ 5 s	T _{sd}	260	°C
Thermal resistance junction/ ambient	mounted on PC board (pad size > 16 mm ²)	R _{thJA}	400	K/W

Optical and Electrical Characteristics T_{amb} = 25 °C, unless otherwise specified

Red

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Parameter	Test condition	Part	Symbol	Min	Тур.	Max	Unit
Luminous intensity 2)	I _F = 10 mA	TLMD3100	I _V	10	20		mcd
		TLMD3101	I _V	16		50	mcd
Luminous intensity 1)	I _F = 10 mA	TLMD3105	I _V	10		32	mcd
Luminous intensity	I _F = 1 mA		I _V		2		mcd
Dominant wavelength	I _F = 10 mA		λ_{d}		648		nm
Peak wavelength	I _F = 10 mA		λ_{p}		650		nm
Angle of half intensity	I _F = 10 mA		φ		± 60		deg
Forward voltage	I _F = 20 mA		V _F		1.8	2.2	V
Reverse voltage	I _R = 10 μA		V _R	6	15		V
Junction capacitance	V _R = 0, f = 1 MHz		C _j		15		pF

¹⁾ in one Packing Unit I_{Vmax}/I_{Vmin} ≤ 1.6

 $^{^{2)}}$ in one Packing Unit $I_{Vmax}/I_{Vmin} \leq 2.0$



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Typical Characteristics ($T_{amb} = 25$ °C unless otherwise specified)

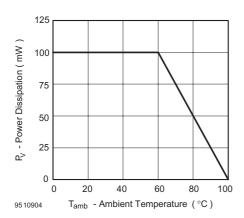


Figure 1. Power Dissipation vs. Ambient Temperature

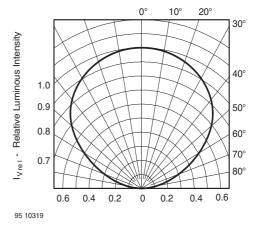


Figure 4. Rel. Luminous Intensity vs. Angular Displacement

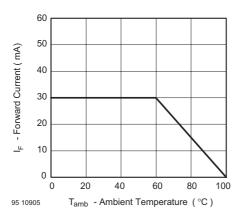


Figure 2. Forward Current vs. Ambient Temperature for InGaN

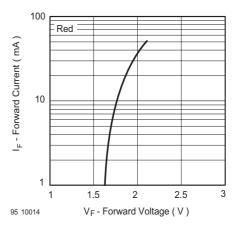


Figure 5.

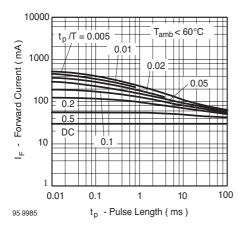


Figure 3. Pulse Forward Current vs. Pulse Duration

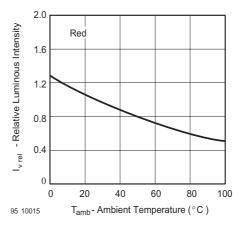


Figure 6. Rel. Luminous Intensity vs. Ambient Temperature

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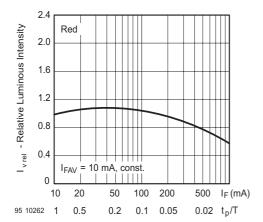


Figure 7. Rel. Lumin. Intensity vs. Forw. Current/Duty Cycle

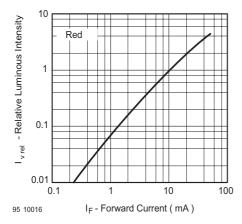


Figure 8. Relative Luminous Intensity vs. Forward Current

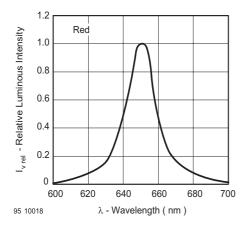


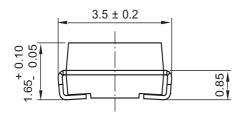
Figure 9. Relative Intensity vs. Wavelength

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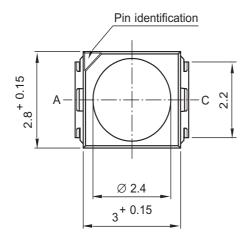
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Package Dimensions in mm





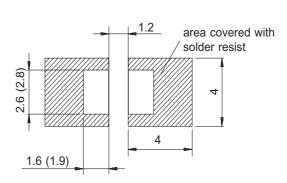
Mounting Pad Layout



Drawing-No.: 6.541-5025.01-4

Issue: 7; 05.04.04

95 11315



Dimensions: IR and Vaporphase (Wave Soldering)

TLMD310.

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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operatingsystems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

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